

### **INCHANGE SEMICONDUCTOR**

## isc P-Channel Mosfet Transistor

## IRF9530

### FEATURES

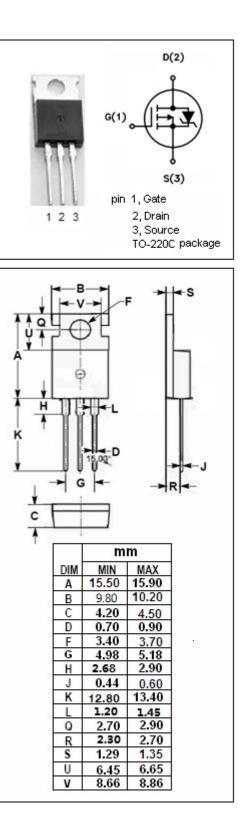
- -12A, -100V
- Single pulse avalanche energy rated
- Static Drain-Source On-Resistance: R<sub>DS(on)</sub> =0.3 Ω (Max)
- SOA is power dissipation limited
- Nanosecond switching speeds
- Linear transfer characteristics
- Minimum Lot-to-Lot variations for robust device performance and reliable operation

#### DESCRITION

• The power MOSFET is designed for applications such as switching regulators,switching convertors,motor drivers,relay drivers and drivers for high power bipolar switching transistors requiring high speed and low gate drive power

### • ABSOLUTE MAXIMUM RATINGS(Ta=25°C)

SYMBOL	ARAMETER	VALUE	UNIT					
V <sub>DSS</sub>	Drain-Source Voltage (V <sub>GS</sub> =0)	-100	V					
V <sub>GS</sub>	Gate-Source Voltage	±20	V					
ID	Drain Current-continuous@ TC=25℃	-12	А					
I <sub>DM</sub>	Drain Current-Single Plused	-48	А					
P <sub>tot</sub>	Total Dissipation@TC=25°C	75	W					
Tj	Max. Operating Junction Temperature	-55~150	°C					
T <sub>stg</sub>	Storage Temperature Range	-55~150	°C					
THERMAL CHARACTERISTICS								
SYMBOL	PARAMETER		UNIT					
Rth j-c	Thermal Resistance,Junction to Case	1.67	°C/W					
R <sub>th j-a</sub>	Thermal Resistance, Junction to Ambient	62.5	°C/W					



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### **ELECTRICAL CHARACTERISTICS**

#### $T_{\text{C}}\text{=}25^{\circ}\!\!\!\!\mathrm{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN	TYPE	МАХ	UNIT
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0; I <sub>D</sub> =-0.25mA	-100			V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}$ = $V_{GS}$ ; I <sub>D</sub> =-0.25mA	-2.0		-4.0	V
$V_{\text{SD}}$	Diode Forward On-voltage	I <sub>S</sub> = -12A ;V <sub>GS</sub> = 0			-1.5	V
R <sub>DS(on)</sub>	Drain-Source On-Resistance	V <sub>GS</sub> = -10V; I <sub>D</sub> = -6.5A			0.3	Ω
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> = ±20V;V <sub>DS</sub> = 0			±100	nA
IDSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> =-100V; V <sub>GS</sub> = 0			-25	μA
Gfs	Forward Transconductance	I <sub>D</sub> =-6.5A	2			S
t <sub>d(on)</sub>	Turn-on Delay Time	I <sub>D</sub> =-12A;			60	
tr	Rise Time	V <sub>DD</sub> =50V;			140	
$t_{d(off)}$	Turn-off Delay Time	R <sub>G</sub> =50 Ω ; V <sub>GS</sub> =10V			140	ns
t <sub>f</sub>	Fall Time				140	

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